

5CH PMU with HV&LV Buck, LDO, Boost, Super Capacitor Charger

Features

- 5CH: 2CH Buck, LDO, Boost, Super Capacitor Charger
- CH1 Buck: Standoff 50V, V_{IN} 7.5-42V, V_{OUT} =3.3V, 0.6A, 700kHz, PFM Mode for High Efficiency in Light Load
- CH2 Buck: V_{IN} 2.5V-5.5V or 3.3V, V_{OUT} =0.6V- V_{IN} , 0.6A, 1.5MHz, PFM Mode for High Efficiency in Light Load
- CH3 LDO: V_{IN} 2.5V-5.5V or 3.3V, V_{OUT} =1.0V-4.5V, 500mA High Speed Low Power LDO
- CH4 Boost: V_{IN} 0.4V-2.55V/ V_{OUT} V_{IN} -18V, 1MHz, V_{FB} 0.8V
- CH5 Super Capacitor Charger: $\pm 2\%$ accuracy for Charger CV Voltage, 50mA Constant Charge Current
- Enable Pin to auto-switch Boost and Charger
- Over Current Protection
- Over Voltage Protection
- Short Protection with Foldback-Mode
- Thermal Shutdown
- Available in QFN20-3×3 Package
- -40°C to +85°C Temperature Range

Applications

- PLC Modules
- Power Meters

General Description

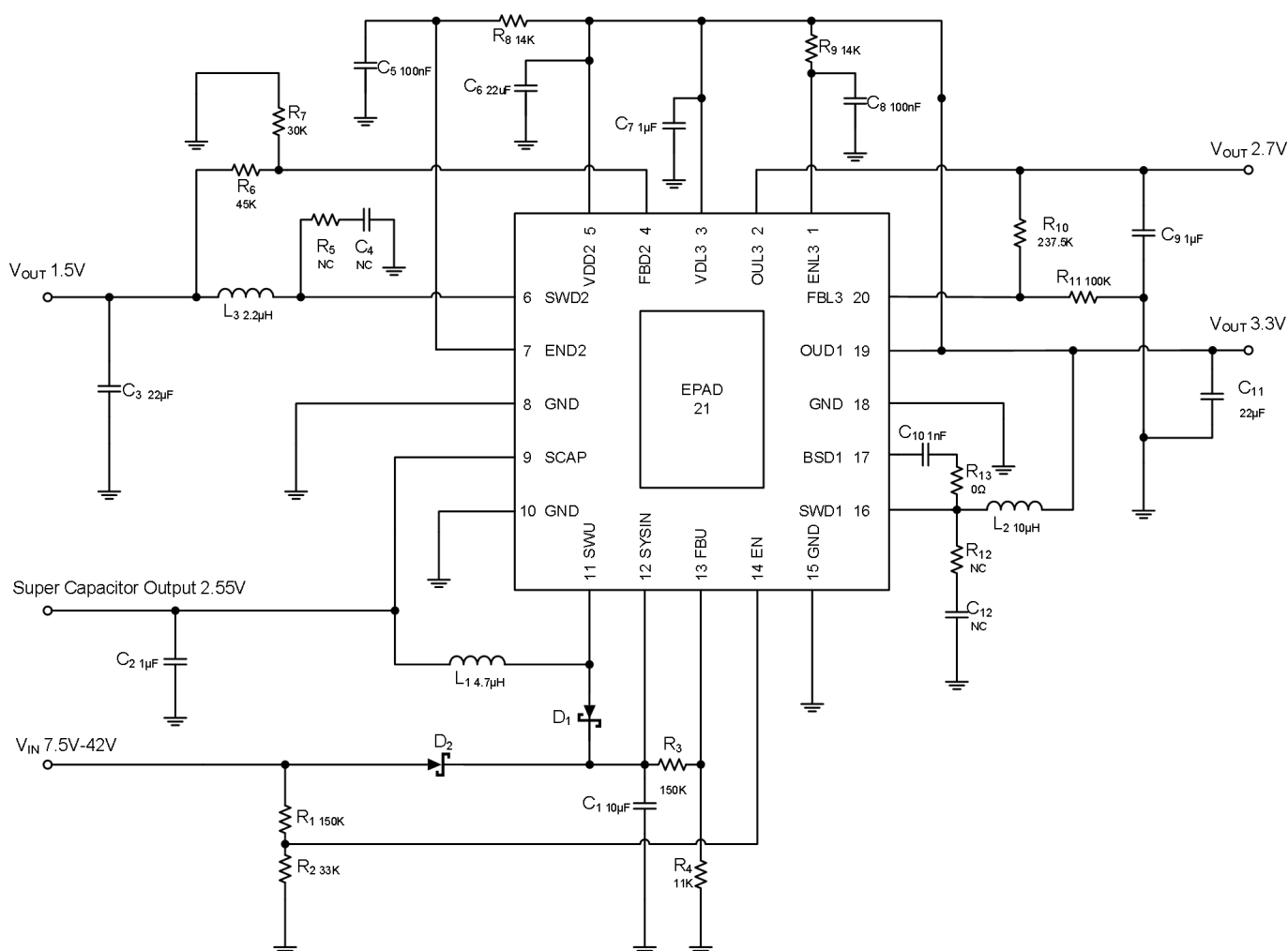
The GP1541 is a 5-channel PMU that includes a 7.5-42V input, high efficiency synchronous HV BUCK converter, a fixed 3.3V output, high efficiency synchronous LV BUCK converter, a highly precise, low noise, positive voltage LDO regulator manufactured using CMOS processes, a low startup, high efficiency 18V BOOST converter and a supercapacitor charger. The HV buck converter withstand input voltage up to 50V and deliver a 3.3V output with 0.6A continuous current. The LV buck converter deliver a 1.5V output with 0.6A continuous current and 1.5MHz switch frequency. The LDO regulator delivers a 2.7V output with 500mA maximum current. The boost converter is capable of providing up to 350mA to 12V output from a single cell supercapacitor or a battery at 2.55V. A linear supercapacitor charger is also integrated with a very high accuracy CV voltage. The output voltage of boost can be adjusted by external resistor divider.

The GP1541 requires a minimal number of readily available, external components and is available in an QFN20-3×3 package.

Order Information

Marking	Part No.	Model	Description	Package	T/R Qty
1541 <u>YYLL</u>	TBD	GP1541Q01	GP1541Q01 5CH PMU, 42V-3.3V Buck with 50V standoff, LV Buck, LV LDO, 18V Boost, Supercapacitor Charger, QFN20-3×3	QFN20-3×3	3000PCS

Typical Application Circuit

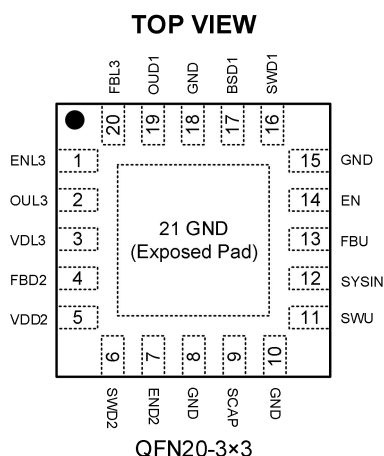


Basic Application Circuit

5CH PMU with HV&LV Buck, LDO, Boost, Super Capacitor Charger

Pin Description

Pin Configuration



Top Marking: 1541YYLL (device code: 1541, YY=year code, LL= lot number code)

Pin Description

Pin	Name	Function
1	ENL3	Enable Pin for LDO.
2	OUL3	Output voltage pin for LDO.
3	VDL3	LDO Power Supply Pin.
4	FBD2	Output Voltage Feedback Pin for BUCK. An internal resistive divider divides the output voltage down for comparison to the internal reference voltage.
5	VDD2	LV BUCK Power Supply Pin.
6	SWD2	Switch Pin for LV BUCK.
7	END2	Enable Pin for LV BUCK.
9	SCAP	SUPER CAPACITOR output. It's internally programed to CV at 2.55V.
11	SWU	Switch Pin for BOOST.
12	SYSIN	System Power Supply Pin.
13	FBU	Feedback Pin for BOOST. Connect FBU to the center point of the external resistor R3 and R4.
14	EN	Enable Pin for auto-switching BOOST and CHARGER: EN=0, BOOST is on, CHARGER is off, EN=1, BOOST is off, CHARGER is on.
16	SWD1	Switch Pin for HV BUCK.



5CH PMU with HV&LV Buck, LDO, Boost, Super Capacitor Charger

17	BSD1	Bootstrap Pin for HV BUCK. A capacitor connected between SWD1 and BSD1 pins is required to form a floating supply across the high-side switch driver.
19	OULD1	Output Voltage Pin for HV BUCK, it's internally setting to 3.3V. It's also the input of CHARGER.
20	FBL3	Output Voltage Feedback Pin for LDO. An internal resistive divider divides the output voltage down for comparison to the internal reference voltage.
8/10/15/18/ 21	GND	Ground Pin and Exposed Pad, it must be connected to Ground.

Specifications

Absolute Maximum Ratings ^{(1) (2)}

Item	Min	Max	Unit
V _{IN} voltage	-0.3	50	V
SWD1, EN voltage	-0.3	50	V
SWU voltage	-0.3	20	V
BSD1 to SWD1 voltage	-0.3	6	V
VDL3	2.0	6	V
OUL3 voltage	1.1	3.6	V
All other Pins voltage	-0.3	6	V
Power dissipation ⁽³⁾	Internally Limited		
Operating junction temperature, T _J	-40	150	°C
Storage temperature, T _{stg}	-55	150	°C
Lead Temperature (Soldering, 10sec.)		260	°C

Note (1): Exceeding these ratings may damage the device.

Note (2): The device is not guaranteed to function outside of its operating conditions.

Note (3): The maximum allowable power dissipation is a function of the maximum junction temperature, T_{J(MAX)}, the junction-to-ambient thermal resistance, R_{θJA}, and the ambient temperature, T_A. The maximum allowable power dissipation at any ambient temperature is calculated using: P_{D(MAX)} = (T_{J(MAX)} - T_A)/R_{θJA}. Exceeding the maximum allowable power dissipation causes excessive die temperature, and the regulator goes into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage. Thermal shutdown engages at T_J=160°C (typical) and

5CH PMU with HV&LV Buck, LDO, Boost, Super Capacitor Charger

disengages at $T_J = 130^{\circ}\text{C}$ (typical).

ESD Ratings

Item	Description	Value	Unit
$V_{(\text{ESD-HBM})}$	Human Body Model (HBM) ANSI/ESDA/JEDEC JS-001-2014 Classification, Class: 2	± 2000	V
$V_{(\text{ESD-CDM})}$	Charged Device Mode (CDM) ANSI/ESDA/JEDEC JS-002-2014 Classification, Class: C0b	± 200	V
$I_{\text{LATCH-UP}}$	JEDEC STANDARD NO.78E APRIL 2016 Temperature Classification, Class: I	± 150	mA

Recommended Operating Conditions

Item	Min	Max	Unit
Operating junction temperature ⁽¹⁾	-40	125	$^{\circ}\text{C}$
Operating temperature range	-40	85	$^{\circ}\text{C}$
SYSTEM Input voltage V_{IN}	7.5	42	V
HV BUCK Output current	0	0.6	A
LV BUCK Output current	0	0.6	A
LDO Output current	0	500	mA

Note (1): All limits specified at room temperature ($T_A = 25^{\circ}\text{C}$) unless otherwise specified. All room temperature limits are 100% production tested. All limits at temperature extremes are ensured through correlation using standard Statistical Quality Control (SQC) methods. All limits are used to calculate Average Outgoing Quality Level (AOQL).

Thermal Information ⁽¹⁾⁽²⁾

Item	Description	Value	Unit
$R_{\theta JA}$	Junction-to-ambient thermal resistance ⁽¹⁾⁽²⁾	40.2	$^{\circ}\text{C/W}$
$R_{\theta JC(\text{top})}$	Junction-to-case (top) thermal resistance	49.7	$^{\circ}\text{C/W}$
$R_{\theta JB}$	Junction-to-board thermal resistance	15.7	$^{\circ}\text{C/W}$
ψ_{JT}	Junction-to-top characterization parameter	0.6	$^{\circ}\text{C/W}$



5CH PMU with HV&LV Buck, LDO, Boost, Super Capacitor Charger

ψ_{JB}	Junction-to-board characterization parameter	15.9	$^{\circ}\text{C}/\text{W}$
$R_{\theta JC}$	Junction-to-case (Bottom) thermal resistance	4.1	$^{\circ}\text{C}/\text{W}$

Note (1): The package thermal impedance is calculated in accordance to JESD 51-7.

Note (2): Thermal Resistances were simulated on a 4-layer, JEDEC board.

Electrical Characteristics (1) (2) (3)

$V_{IN}=12\text{V}$, $T_A=25^{\circ}\text{C}$, unless otherwise specified.

Parameter	Test Conditions	Min	Typ.	Max	Unit
BUCK1					
BUCK1 Input Standoff Voltage			50		V
BUCK1 Input Voltage Range		7.5		42	V
BUCK1 Input OVP	Rising, Hysteresis=1V		45		V
Supply Current (Quiescent)	$V_{EN}=3.0\text{V}$, $V_{FB}=1.1\text{V}$		0.6	0.8	mA
Supply Current (Shutdown)	$V_{EN}=0$ or $EN = \text{GND}$			4	μA
VOUD1 Voltage	Internally Setting	3.230	3.300	3.370	V
High-Side Switch On-Resistance	$I_{SWD}=100\text{mA}$		500		$\text{m}\Omega$
Low-Side Switch On-Resistance	$I_{SWD}=100\text{mA}$		300		$\text{m}\Omega$
High-Side Switch Leakage Current	$V_{EN}=0\text{V}$, $V_{SWD}=0\text{V}$		0	1	μA
Upper Switch Current Limit	Minimum Duty Cycle	1			A
Low-Side Zero Crossing Limit			20		mA
Oscillation Frequency			700		KHz
Minimum On-Time			90		nS
Under-Voltage Lockout Threshold	Wake up V_{IN} Voltage		7.5		V
	Shutdown V_{IN} Voltage		5.5		V
	Hysteresis V_{IN} voltage		2		V
BUCK2					
BUCK2 Input Voltage Range		2.5		5.5	V

**5CH PMU with HV&LV Buck, LDO, Boost, Super Capacitor Charger**

Supply Current (Quiescent)	$V_{EN}=3.0V$		40		μA
Supply Current (Shutdown)	$V_{EN}=0$ or $EN = GND$		0.1		μA
FBD2 Voltage		0.585	0.600	0.615	V
High-Side Switch On-Resistance	$I_{SW}=100mA$		300		$m\Omega$
Low-Side Switch On-Resistance	$I_{SW}=-100mA$		200		$m\Omega$
Upper Switch Current Limit	Minimum Duty Cycle	1.5			A
Switching Frequency			1.5		MHz
Under-Voltage Lockout Threshold	Wake up V_{IN} Voltage		2.3	2.45	V
	Shutdown V_{IN} Voltage	1.75	1.9		V
	Hysteresis V_{IN} voltage		400		mV
Soft Start			700		μS
BOOST					
BOOST Input Range		0.7		6	V
FBU Feedback Voltage			800		mV
FBU Input Current	FBU=0 and 2V			1	μA
BOOST Output Voltage Range		5		18	V
BOOST Switching Frequency			1		MHz
Maximum Duty Cycle		95			%
NMOS Switch On Resistor	$I_{SWU}=100mA$		55		$m\Omega$
SWU Leakage Current	$V_{EN}=0V$, $V_{SWU}=0V$			10	μA
LDO					
LDO Input Voltage Range		2.5		5.5	V
FBL3 Voltage		784	800	816	mV
Supply Current	$V_{IN}=V_{OUT(S)}+1.0 V$		28		μA
Shutdown Current	$V_{IN}=5V$, $V_{EN}=0$			0.1	μA
Power Supply Rejection Ratio	$V_{OUT}=2.5V$, $f = 1KHz$	-	70	-	dB
	$I_{OUT}=20mA$, $f = 10kHz$		60	-	
Short-Circuit Current Limit			500		mA
EN "High Voltage		1			V
EN "Low" Voltage				0.5	V
EN "High Current	$V_{IN}=V_{EN}=V_{OUT(T)}+1V$	-0.1		0.1	μA

**5CH PMU with HV&LV Buck, LDO, Boost, Super Capacitor Charger**

EN "Low" Current	$V_{IN}=V_{OUT(T)}+1V$, $V_{EN}=V_{SS}$	-0.1		0.1	μA
CHARGER	Shutdown V_{IN} Voltage	1.75	1.9		V
Quiescent Current	Hysteresis V_{IN} voltage		400		mV
Soft Start			700		μS
Charge Current			50		mA
Dropout Voltage	$I_{OUT}=30mA$		70		mV
Reverse Leakage Current	SCAP=3.5V, OUTD=3.3V			30	μA
SYSTEM					
Quiescent Current	FBU=0.9V, OUTD=3.6V		0.7		mA
EN Input Current			0		μA
EN Rising Threshold			1.50		V
EN Falling Threshold			1.34		V
EN Hysteresis			0.16		V
Soft Start			550		μS
Thermal Shutdown			150		$^{\circ}C$
Thermal Hysteresis			30		$^{\circ}C$

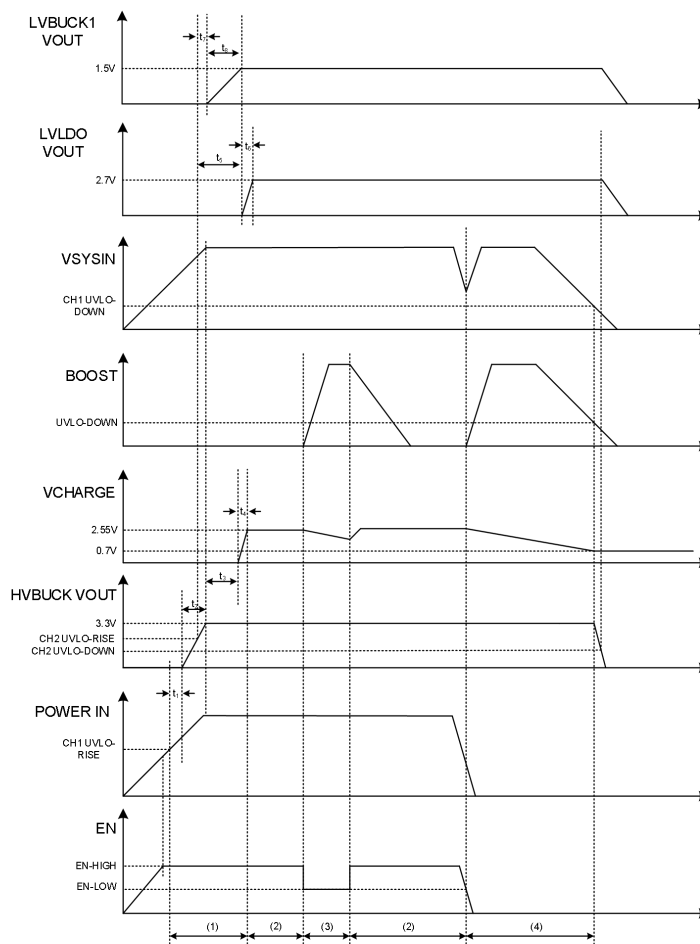
Note (1): MOSFET on-resistance specifications are guaranteed by correlation to wafer level measurements.

Note (2): Thermal shutdown specifications are guaranteed by correlation to the design and characteristics analysis.

Note (3): The sum power of Buck1, Buck2, LDO cannot exceed 1.65W.

Timing Chart

5CH PMU with HV&LV Buck, LDO, Boost, Super Capacitor Charger



Remark

t_1 : HVBuck start delay time is about 200 μ s. t_2 : HVBuck soft-start time is about 550 μ s.

t_3 : V_C start delay time is about 3ms. t_4 : V_C rise time is related to super capacitor capacitance and charging current.

t_5 : LDO start delay time is about 900 μ s. t_6 : LDO soft-start time is about 200 μ s.

t_7 : LVBUCK start delay time is about 200 μ s. t_8 : LVBUCK soft-start time is about 700 μ s.

(1) Startup state. (2) Normal state. (3) EN controls super capacitor charging and discharging.

(4) Input power down, super capacitor discharge.

Note: The length of the line in the timing diagram has nothing to do with the actual ratio, only for schematic reference.

When the external input reaches the UVLO-RISE of CH1, 3.3V starts to rise after the delay time of t_1 . After a delay time t_7 when CH1 VOUT rise to LVBUCK UVLO-RISE, LVBUCK start. When LVBUCK VOUT rise to the setting voltage, LDO start. When the 3.3V rise is completed, then after the

5CH PMU with HV&LV Buck, LDO, Boost, Super Capacitor Charger

delay time of t_3 , CH5 starts to start. EN can follow the external input (affected by the ratio of R_1 and R_2), or it can add a control signal to control the charging and discharging of the super capacitor.

Functions Description

The GP1541 is a 5-channel PMU that includes a 7.5-42V input, high efficiency synchronous HV BUCK converter, fixed 3.3V output, high efficiency synchronous LV BUCK converter, a highly precise, low noise, positive voltage LDO regulator with 2.7V output manufactured using CMOS processes, a low startup, high efficiency 18V BOOST converter and a supercapacitor charger. The HV buck converter withstand input voltage up to 50V and deliver a 3.3V output with 0.6A continuous current. The LV buck converter delivers a 1.5V output with 0.6A continuous current and 1.5MHz switch frequency. The LDO regulator delivers a 2.7V output with 350mA maximum output current. The boost converter is capable of providing up to 350mA to 12V output from a single cell supercapacitor or a battery at 2.55V. A linear supercapacitor charger is also integrated with a very high accuracy CV voltage. The output voltage of boost can be adjusted by external resistor divider.

HV Buck converter

The HV BUCK is a wide input range, high-efficiency, synchronous step-down switching regulator which output is fixed at 3.3V, capable of delivering up to 0.6A of output current. With a fixed switching frequency of 700KHz, this current mode PWM controlled converter allows the use of small external components, such as ceramic input and output caps, as well as small inductors. It also employs a proprietary control scheme that switches the device into a power save mode during light load, thereby extending the range of high efficiency operation. An OVP function protects the IC itself and its downstream system against input voltage surges. With this OVP function, the IC can stand off input voltage as high as 42V.

LV Buck converter

The LV BUCK is a wide input range, high-efficiency, synchronous step-down switching regulator which output is fixed at 1.5V, capable of delivering up to 0.6A of output current. With a fixed switching frequency of 1.5MHz, this current mode control converter allows the use of small external components, such as ceramic input and output caps, as well as small inductors. It also employs a proprietary control scheme that switches the device into a power save mode during light load, thereby extending the range of high efficiency operation.

LDO regulator

The LDO is highly precise, low noise, positive voltage LDO regulators manufactured using CMOS processes. It achieves high ripple rejection and low dropout and consists of a standard voltage source,

5CH PMU with HV&LV Buck, LDO, Boost, Super Capacitor Charger

an error correction, current limit, and a phase compensation circuit plus a driver transistor. External output feedback, customers can easily get the required voltage. In order to make the load current does not exceed the current capacity of the output transistor, built-in over-current protection, over temperature protection and short circuit protection. The internal op amp with advanced structure, the output capacitor can be omitted.

Boost converter

The BOOST is a high efficiency no-synchronous step up converter. It can deliver at least 4.2W of power from 2.55V, 0.35A at 12V output. A switching frequency of 1MHz solution footprint by allowing the use of tiny and low-profile inductors and ceramic capacitors. The output of BOOST can be set by external resistor divider at FBU pin.

CHARGER

The CHARGER is fully integrated constant current (CC)/constant voltage (CV) function. It can deliver a 50mA charge current with a final float voltage of 2%. It also integrated reverse protection, when OUTD is low than SCAP to protect the Supercapacitor not to discharge.

Enable

EN is a digital control pin that turns the BOOST and CHARGER on and off, Drive EN High to turn on the CHARGER and turn off the BOOST, drive it Low to turn off the CHARGER and turn on the BOOST.

Over-Temperature Protection

Thermal protection disables BUCK, BOOST and CHARGER when the junction temperature rises to approximately 150°C, allowing the device to cool down. When the junction temperature cools to approximately 130°C, the output circuitry is again enabled. Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit may cycle on and off. This cycling limits regulator dissipation, protecting the device from damage as a result of overheating.

Under-Voltage Lockout (UVLO)

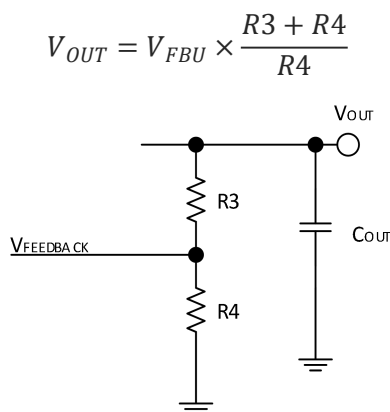
Under-voltage lockout (UVLO) protects the chip from operating at an insufficient supply voltage. UVLO protection monitors the internal regulator voltage. When the voltage is lower than UVLO threshold voltage, the device is shut off. When the voltage is higher than UVLO threshold voltage, the device is enabled again.

Applications Information

Setting the BOOST Output Voltage

5CH PMU with HV&LV Buck, LDO, Boost, Super Capacitor Charger

GP1541 require an input capacitor, an output capacitor and an inductor. These components are critical to the performance of the device. GP1541 are internally compensated and do not require external components to achieve stable operation. The output voltage can be programmed by resistor divider.



BOOST On/Off and Super capacitor charge and discharge vs. En threshold

The GP1541 EN pin also serves as a threshold voltage for auto-switching Supercapacitor Charger and the BOOST. When the VIN drops, and EN's voltage is below the falling threshold ($V_{EN_FALLING} = 1.34V$), the Supercapacitor Charger is disabled and the BOOST is then enabled at the same time. With a resistor ladder, R1 from VIN to EN and R2 from EN to GND, the VIN dropping threshold thus is programmed by the equation below.

$$V_{INT_threshold} = V_{EN_FALLING} \times \left(1 + \frac{R1}{R2}\right)$$

Setting the LVBUCK Output Voltage

LVBUCK channel require an output capacitor, and an inductor. These components are critical to the performance of the device. Which is internally compensated and do not require external components to achieve stable operation. The output voltage can be programmed by resistor divider.

$$V_{OUT1} = V_{FBD2} \times \frac{R6 + R7}{R7}$$

Setting the LDO Output Voltage

The LDO require an input capacitor and an output capacitor. These components are critical to the performance of the device. The output voltage can be programmed by resistor divider.

5CH PMU with HV&LV Buck, LDO, Boost, Super Capacitor Charger

$$V_{OUT} = V_{FBL3} \times \frac{R10 + R11}{R11}$$

Selecting the Inductor for BUCK

The recommended inductor values are shown in the application diagram. It is important to guarantee the inductor core does not saturate during any foreseeable operational situation. The inductor should be rated to handle the peak load current plus the ripple current: Care should be taken when reviewing the different saturation current ratings that are specified by different manufacturers. Saturation current ratings are typically specified at 25°C, so ratings at maximum ambient temperature of the application should be requested from the manufacturer.

$$L = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times \Delta I_L \times F_{OSC}}$$

Where ΔI_L is the inductor ripple current. Choose inductor ripple current to be approximately 30% if the maximum load current. The maximum inductor peak current is:

$$I_{L(MAX)} = I_{LOAD} + \frac{\Delta I_L}{2}$$

Under light load conditions below 100mA, larger inductance is recommended for improved efficiency.

Selecting the Inductor for BOOST

The boost converter can utilize small surface mount and chip inductors due to the fast 1MHz switching frequency. Inductor values between 2.2μH and 10μH are suitable for most applications. Larger values of inductance will allow slightly greater output current capability by reducing the inductor ripple current. Increasing the inductance above 10μH will increase size while providing little improvement in output current capability. The minimum boost inductance value is given by:

$$L > \frac{V_{IN} \times (V_{OUT} + V_{DIODE} - V_{IN})}{F_S \times I_{RIPPLE} \times (V_{OUT} + V_{DIODE})}$$

Where

- I_{RIPPLE} : Peak-to-Peak inductor current
- V_{IN} : Input voltage
- V_{OUT} : Output voltage
- V_{DIODE} : Output diode Forward Voltage
- F_S : Switching frequency, Hertz

The inductor current ripple is typically set for 20% to 40% of the maximum inductor current. High frequency ferrite core inductor materials reduce frequency dependent power losses compared to cheaper powdered iron types, improving efficiency. The inductor should have low DCR(series resistance of the winding) to reduce the I^2R power losses, and must not saturate at peak inductor current levels. Molded chokes and some chip inductors usually.

5CH PMU with HV&LV Buck, LDO, Boost, Super Capacitor Charger

Selecting the Output Capacitor

Special attention should be paid when selecting these components. The DC bias of these capacitors can result in a capacitance value that falls below the minimum value given in the recommended capacitor specifications table.

The ceramic capacitor's actual capacitance can vary with temperature. The capacitor type X7R, which operates over a temperature range of -55°C to $+125^{\circ}\text{C}$, will only vary the capacitance to within $\pm 15\%$. The capacitor type X5R has a similar tolerance over a reduced temperature range of -55°C to $+85^{\circ}\text{C}$. Many large value ceramic capacitors, larger than $1\mu\text{F}$ are manufactured with Z5U or Y5V temperature characteristics. Their capacitance can drop by more than 50% as the temperature varies from 25°C to 85°C . Therefore, X5R or X7R is recommended over Z5U and Y5V in applications where the ambient temperature will change significantly above or below 25°C .

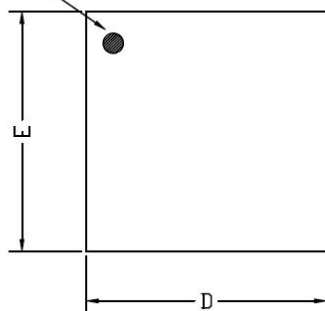
Tantalum capacitors are less desirable than ceramic for use as output capacitors because they are more expensive when comparing equivalent capacitance and voltage ratings in the $22\mu\text{F}$ to $44\mu\text{F}$ range. Another important consideration is that tantalum capacitors have higher ESR values than equivalent size ceramics. This means that while it may be possible to find a tantalum capacitor with an ESR value within the stable range, it would have to be larger in capacitance (which means bigger and more costly) than a ceramic capacitor with the same ESR value. It should also be noted that the ESR of a typical tantalum will increase about 2:1 as the temperature goes from 25°C down to -40°C , so some guard band must be allowed.



5CH PMU with HV&LV Buck, LDO, Boost, Super Capacitor Charger

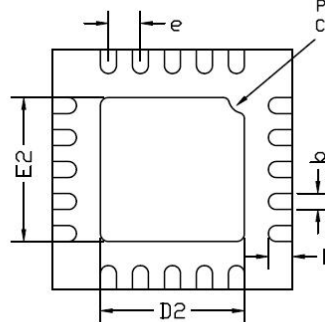
Package Description

PIN 1 DOT
BY MARKING

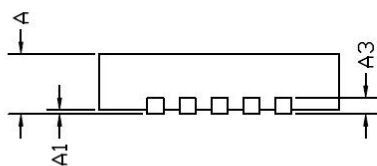


TOP VIEW

PIN #1 IDENTIFICATION
CHAMFER 0.20MM



BOTTOM VIEW

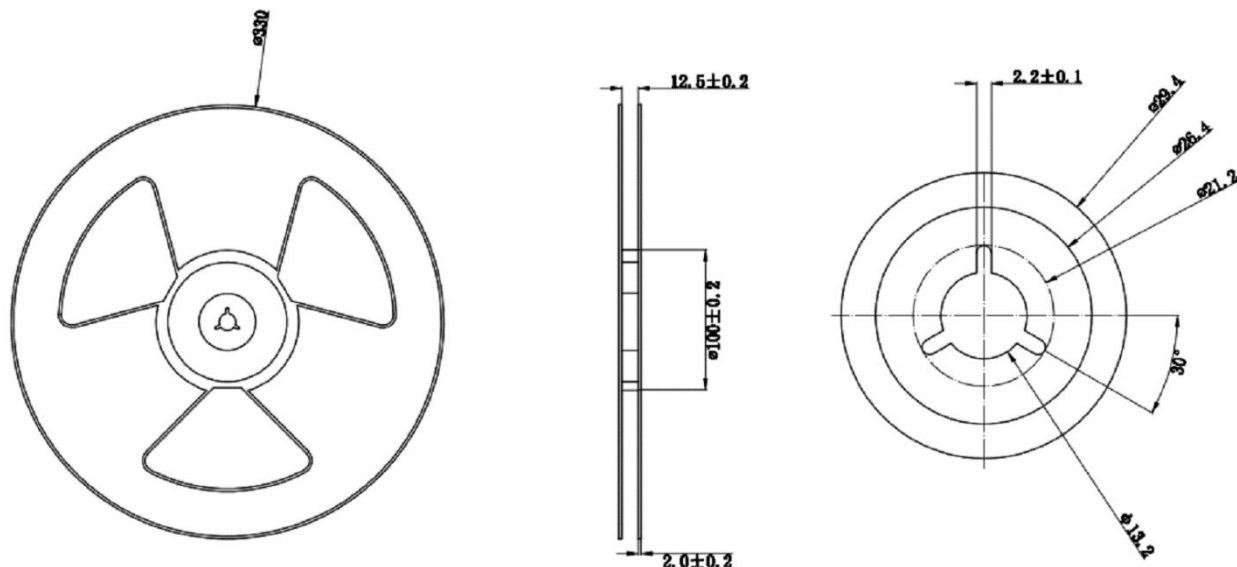


SIDE VIEW

COMMON DIMENSIONS(MM)			
PKG. REF.	W/VERY VERY THIN		
	MIN.	NOM.	MAX
A	0.70	0.75	0.80
A1	0.00	-	0.05
A3	0.20 REF.		
D	2.95	3.00	3.05
E	2.95	3.00	3.05
b	0.15	0.20	0.25
L	0.25	0.30	0.35
D2	1.65	1.80	1.90
E2	1.65	1.80	1.90
e	0.40 BSC		

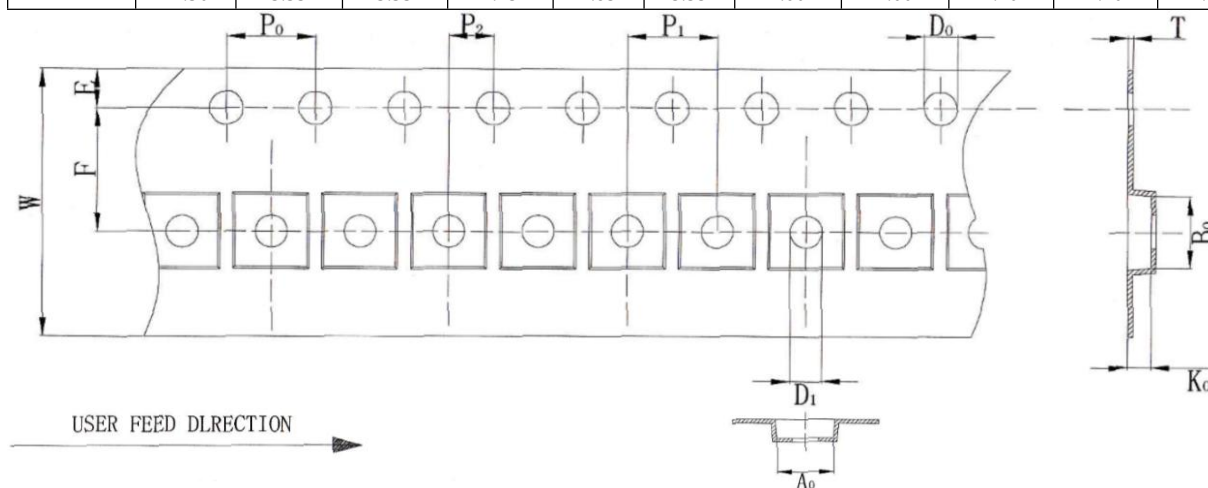
5CH PMU with HV&LV Buck, LDO, Boost, Super Capacitor Charger

Tape and Reel Information



Specification	Appropriate Types	Unit
13*12	QFN 3*3	mm

ITEM(mm)	W(mm)	Ao(mm)	Bo(mm)	Ko(mm)	E(mm)	F(mm)	D1(mm)	Do(mm)	Po(mm)	P1(mm)	P2(mm)	t(mm)
MIN	11.70	3.13	3.13	0.95	1.65	5.45	---	---	3.90	3.90	1.95	0.18
NOM	12.00	3.23	3.23	1.05	1.75	5.50	1.50	1.50	4.00	4.00	2.00	0.23
MAX	12.30	3.33	3.33	1.15	1.85	5.55	1.60	1.60	4.10	4.10	2.05	0.28



Note: (1) The cumulative error of any ten gears does not exceed $\pm 0.2\text{mm}$. (2) Material thickness is subject to carrier tape edge measurement. (3) Straight line bending within 250mm of any length of carrier tape should be less than 1mm. (4) If not specified, the tolerance range: $\pm 0.1\text{mm}$. (5) Ao, Bo is the depth dimension of the innermost bottom of the cavity. (6) Where the appearance of the cavity is not marked, the chamfer R is 0.2-0.3mm.

5CH PMU with HV&LV Buck, LDO, Boost, Super Capacitor Charger

Soldering Parameters

Reflow Condition		Pb-Free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	+150°C
	- Temperature Max ($T_{s(max)}$)	+200°C
	- Time (Min to Max) (t_s)	60-180 secs.
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/sec. Max.
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max.
Reflow	- Temperature (T_L) (Liquidus)	+217°C
	- Temperature (t_L)	60-150 secs.
Peak Temp (T_P)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		30 secs. Max.
Ramp-down Rate		6°C/sec. Max.
Time 25°C to Peak Temp (T_P)		8 min. Max.
Do not exceed		+260°C

